A wide variety of products including dust-proof type







■ Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	100mΩ max.
Travel (mm)	0.25

■ Product Line

Top push type

Product No.	Operating force	Operating direction	Operating Operating life (5mA 5V DC)		Height	Minimum ord Japan	er unit (pcs.) Export	Drawing No.
			(0			Japan	Ελρυιτ	
SKHUAKE010	0.98N		300,000 cycles -	Green				
SKHUALE010	1.57N	Top push		300,000 cycles —	Black	2.5mm	3,000	3,000
SKHUAME010	2.55N		100,000 cycles	Red				

With ground terminal type

Product No.	Operating force	Operating	Operating life	Stem color	Height	Minimum ord	Drawing	
1100001110.	Operating force	direction	(5mA 5V DC)	010111 00101	rioigrit	Japan	Export	No.
SKHUPKE010	0.98N		300,000 cycles Green Black					
SKHUPLE010	1.57N	Top push		Jood, Jood Cycles	Black	2.5mm	3,000	3,000
SKHUPME010	2.55N		100,000 cycles	Red				

Dust-proof type

Product No.	Operating force	Operating 0		Stem color	Height	Minimum ord	Drawing	
T TOUGGE TNO.	Operating force	direction		Sterri color		Japan	Export	No
SKHUBHE010	1.57N	Top push	50,000 cycles	Brown	3.1mm	3,000	3,000	3

Dust-proof and with ground terminal type

Product No.	Operating force	Operating	Operating life	Stem color	Height	Minimum ord	Drawing	
T TOUGET NO.	Operating force	direction	(5mA 5V DC)	Sterri color Height	Japan	Export	No	
SKHUQHE010	1.57N	Top push	50,000 cycles	Brown	3.1mm	3.000	3.000	4
SKHUQGE010	2.55N	TOP PUSIT		Red	3.1111111	3,000	3,000	4

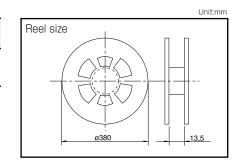
■ Packing Specifications

Taping

Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
3,000	30,000	30,000	12	395×395×205

Note

For reels of 330mm diameter, please inquire.





■ Dimensions

No.	Photo	Style	PC board land dimensions (Viewed from switch mounting face)
1	Top push type	7.2 6.2 2 1 3 Stem	9.5
2	With ground terminal type	7.2 6.2 1 2 3 Stem	9.5 Quantity of the second terminal land of the second te
3	Dust-proof type	7.2 6.2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	9.5
4	Dust-proof and with ground terminal type	7.2 6.2 0 3 Stem	9.5 4

■ Circuit Diagram

Top push type	With ground terminal type
① 	①

	T				Sharp Fe	eeling Type				
	Type				Surfac	e Mount				
	Series	SKST	SKRA	SKHM	SKHU	SKTD	SKSN	SKTG	SKSL	
	Photo		9		· C			0.0	O.A.	
	Features	Middle	e travel	_	_	Low-profile	Mid-mount	Half-n	nount	
	Water-proof	_	0	_	0	•	_	•	_	
	Dust-proof	_	0	_	0	•	_	•	_	
	IP standard	_	67 equivalent	_	_	67 equivalent	_	67 equivalent	_	
Operatir	Top push	•	•	•	•	_	_	_	_	
directio		_	_	_	_	•	•	•	•	
	W			6.2	6.2	3.9	6.2	5.2	4.5	
Dimensio (mm)	ons D	- □8.5	□6.2	6.5	6.3	2.9	3	3.5	2.6	
(11111)	Н	3.95	3.5/5.2	3.1	2.5/3.1	1.55	3.5	1.55	2.2	
Operation force coverage	2N to 3N	4N to 10N			1	\$		\$	1	
	Travel (mm)	0.9	See the relevant pages for respective product description	0.25		0.15	0.2	0.15		
G	round terminal	_	_	•	•	•	•	•	•	
Operatin	g temperature range	-40℃ 1	to +90℃	−40°C to +85°C		-30°C to +85°C	-40°C to +85°C	-30℃ to +85℃		
Aı	utomotive use	•	0	_	0	_	_	_	_	
	Life Cycle	★ 2	*3	*3	*3	* 2	* 2	* 2	* 2	
	Rating (max.) (Resistive load)	50mA 16V DC								
Electrical	Rating (min.) (Resistive load)				10μΑ	A 1V DC				
performance	Insulation resistance		100MΩ min. 100V DC 1min.							
	Voltage proof		250V A	C 1min. 100V AC 1min. 250V AC 1min.					100V AC 1min.	
Vibration			10 to	55 to 10Hz/n in the 3 dire	nin., the amplit ction of X, Y a	ude is 1.5mm fo	or all the freque respectively	encies,		
Durability	Lifetime			Shall be in	n accordance with individual specifications.					
	Cold	-40°C	40℃ 1,000h -40℃ 96h							
Environmental performance	Dry heat	90℃	1,000h	90°C 96h 85°C 96h 90°C 96h 85°C 96h 9					90℃ 96h	
	Damp heat	60°C, 90 1,0	to 95%RH 00h	60°C, 90 to 95%RH 96h						
	Page	230	231	232	233	235	236	237	238	

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

TACT Switch™ Soldering Conditions · · · · · · · · · · · · · · · · · · ·	
TACT Switch™ Cautions · · · · · · · · · · · · · · · · · · ·	

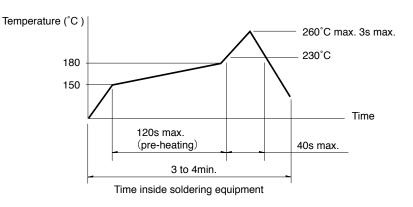
Notes

^{1.} The automotive operating temperature range to be individually discussed upon request.

^{2.} lacktriangle Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

■ Condition for Reflow Available for Surface Mount Type.

Temperature profile



TACT Switch™ / Soldering Conditions

Notes

- 1. Please confirm the specifications of our product for the detailed condition.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHL Top Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

■ Manual Soldering

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch TM .
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA CORPORATION, or equivalents.)

